

AT27C010-70PU Datasheet

www.digi-electronics.com



DiGi Electronics Part Number
Manufacturer
Aanufacturer Product Number
Description
Detailed Description

AT27C010-70PU-DG Microchip Technology AT27C010-70PU IC EPROM 1MBIT PARALLEL 32DIP EPROM - OTP Memory IC 1Mbit Parallel 70 ns 32-PD IP

https://www.DiGi-Electronics.com



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
AT27C010-70PU	Microchip Technology
Series:	Product Status:
-	Active
DiGi-Electronics Programmable:	Memory Type:
Verified	Non-Volatile
Memory Format:	Technology:
EPROM	EPROM - OTP
Memory Size:	Memory Organization:
1Mbit	128K x 8
Memory Interface:	Write Cycle Time - Word, Page:
Parallel	
Access Time:	Voltage - Supply:
70 ns	4.5V ~ 5.5V
Operating Temperature:	Mounting Type:
-40°C ~ 85°C (TC)	Through Hole
Package / Case:	Supplier Device Package:
32-DIP (0.600", 15.24mm)	32-PDIP
Base Product Number:	
AT27C010	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	3A991B1B1
HTSUS:	
8542.32.0061	

Features

- Fast read access time 45ns
- Low-power CMOS operation
 - 100µA max standby
 - 25mA max active at 5MHz
- JEDEC standard packages
 - 32-lead PDIP
 - 32-lead PLCC
- 5V ± 10% supply
- High-reliability CMOS technology
 - 2000V ESD protection
 - 200mA latchup immunity
- Rapid programming algorithm 100 μs/byte (typical)
- CMOS- and TTL-compatible inputs and outputs
- Integrated product identification code
- Industrial temperature range
- Green (Pb/halide-free) packaging option

1. Description

The Atmel[®] AT27C010 is a low-power, high-performance 1,048,576-bit, one-time programmable, read-only memory (OTP EPROM) organized as 128K by 8 bits. Thedevice requires only one 5V power supply in normal read mode operation. Any byte can be accessed in less than 45ns, eliminating the need for speed reducing WAIT states on highperformance microprocessor systems.

In read mode, the AT27C010 typically consumes only 8mA. Standby mode supply current is typically less than $10\mu A.$

The AT27C010 is available in a choice of industry standard, JEDEC approved, one-time programmable (OTP) PDIP and PLCC packages. All devices feature two-line control (\overline{CE} , \overline{OE}) to give designers the flexibility to prevent bus contention.

With 128K byte storage capability, the AT27C010 allows firmware to be stored reliably and to be accessed by the system without the delays of mass storage media.

The AT27C010 has additional features to ensure high quality and efficient production use. The rapid programming algorithm reduces the time required to program the part and guarantees reliable programming. Programming time is typically only 100 µs/byte. The integrated product identification code electronically identifies the device and manufacturer. This feature is used by industry standard programming equipment to select the proper programming algorithms and voltages.



1Mb (128K x 8) One-time Programmable, Read-only Memory

Atmel AT27C010

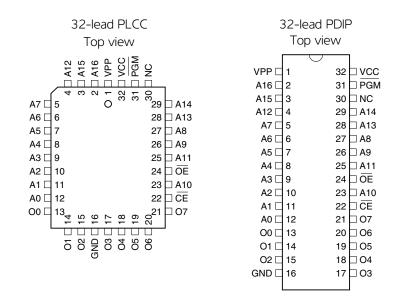
0321N-EPROM-4/11





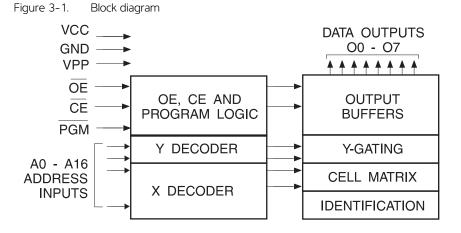
2. Pin configurations

Pin name	Function
A0 - A16	Addresses
00 - 07	Outputs
CE	Chip enable
ŌĒ	Output enable
PGM	Program strobe
NC	No connect



3. System considerations

Switching between active and standby conditions via the chip enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed datasheet limits, resulting in device nonconformance. At a minimum, a 0.1μ F, high-frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the V_{CC} and ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a 4.7μ F bulk electrolytic capacitor should be utilized, again connected between the V_{CC} and ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.



4. Absolute maximum ratings*

Temperature under bias55°C to +125°C
Storage temperature65°C to +150°C
Voltage on any pin with respect to ground2.0V to +7.0V ⁽¹⁾
Voltage on A9 with respect to ground2.0V to +14.0V ⁽¹⁾
V _{PP} supply voltage with respect to ground2.0V to +14.0V ⁽¹⁾

*NOTICE: Stresses beyond those listed under "Absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC, which may undershoot to -2.0V for pulses of less than 20ns. Maximum output pin voltage is V_{CC} + 0.75V DC, which may overshoot to +7.0V for pulses of less than 20ns.

5. DC and AC characteristics

Table 5-1. Op	erating modes
---------------	---------------

Mode/Pin	CE	ŌĒ	PGM	Ai	V _{PP}	Outputs
Read	V _{IL}	V _{IL}	X ⁽¹⁾	Ai	Х	D _{OUT}
Output disable	Х	V _{IH}	Х	X	Х	High Z
Standby	V _{IH}	Х	Х	X	Х	High Z
Rapid program ⁽²⁾	V _{IL}	V _{IH}	V _{IL}	Ai	V _{PP}	D _{IN}
PGM verify	V _{IL}	V _{IL}	V _{IH}	Ai	V _{PP}	D _{OUT}
PGM inhibit	V _{IH}	Х	Х	X	V _{PP}	High Z
Product identification ⁽⁴⁾	V _{IL}	V _{IL}	х	$A9 = V_{H}^{(3)}$ $A0 = V_{H} \text{ or } V_{L}$ $A1 - A16 = V_{L}$	Х	Identification code

Note: 1. X can be V_{IL} or V_{IH} .

2. Refer to programming characteristics.

3. $V_{\rm H} = 12.0 \pm 0.5 V.$

4. Two identifier bytes may be selected. All Ai inputs are held low (V_{IL}) , except A9, which is set to $V_{H'}$ and A0, which is toggled low (V_{IL}) to select the manufacturer's identification byte and high (V_{IL}) to select the device code byte.

Table 5-2. DC and AC operating conditions for read operation

		Atmel AT27C010			
			-70		
Operating temp. (case) Ind.		-40°C - 85°C	-40°C - 85°C		
V _{CC} power supply		5V ± 10%	5V ± 10%		





Symbol	Parameter	Condition	Condition		Max	Units
ILI	Input load current	$V_{IN} = 0V$ to V_{CC}	Ind.		± 1	μA
ILO	Output leakage current	$V_{OUT} = 0V$ to V_{CC}	Ind.		± 5	μA
IPP1 ⁽²⁾	V _{PP} ⁽¹⁾⁾ read/standby current	V _{PP} = V _{CC}			10	μA
) ((1) at an all the second set	I_{SB1} (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$	I_{SB1} (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$		100	μΑ
I _{SB}	$V_{CC}^{(1)}$ standby current I_{SB2} (TTL), $\overline{CE} = 2.0$ to $V_{CC} + 0.5V$		V		1	mA
I _{CC}	V _{CC} active current	$f = 5MHz$, $I_{OUT} = 0mA$, $\overline{CE} = V_{IL}$			25	mA
VIL	Input low voltage			-0.6	0.8	V
V _{IH}	Input high voltage			2.0	V _{CC} + 0.5	V
V _{OL}	Output low voltage	I _{OL} = 2.1mA			0.4	V
V _{OH}	Output high voltage	I _{OH} = -400μA		2.4		V

Table 5-3. DC and operating characteristics for read operation

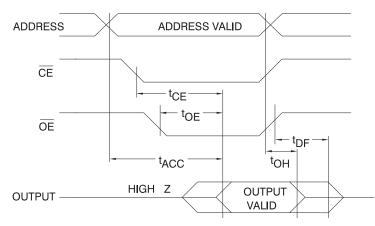
Notes: 1. V_{CC} must be applied simultaneously or before V_{PP} , and removed simultaneously or after V_{PP} .

2. V_{PP} may be connected directly to V_{CC} , except during programming. The supply current would then be the sum of I_{CC} and I_{PP} .

			Atmel AT27C010				
			-45		-70		
Symbol	Parameter	Condition	Min	Max	Min	Max	Units
t _{ACC} ⁽³⁾	Address to output delay	$\overline{CE} = \overline{OE} = V_{IL}$		45		70	ns
t _{CE} ⁽²⁾	CE to output delay	$\overline{OE} = V_{IL}$		45		70	ns
t _{OE} ⁽²⁾⁽³⁾	OE to output delay	$\overline{CE} = V_{IL}$		20		30	ns
t _{DF} ⁽⁴⁾⁽⁵⁾	$\overline{\text{OE}}$ or $\overline{\text{CE}}$ high to output float, whichever occurred first			20		25	ns
t _{OH}	Output hold from address, \overline{CE} or \overline{OE}	Output hold from address, CE or OE, whichever occurred first			7		ns

Table 5-4. AC characteristics for read operation

Figure 5-1. AC waveforms for read operation⁽¹⁾

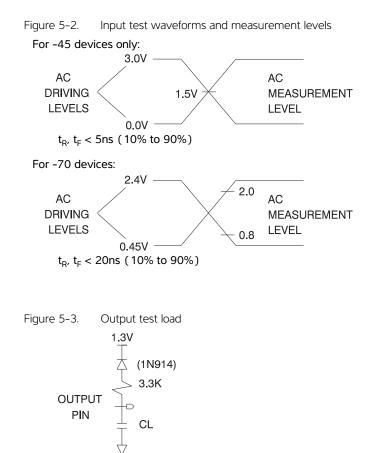


Notes: 1. Timing measurement reference level is 1.5V for -45 devices. Input AC drive levels are $V_{IL} = 0.0V$ and $V_{IH} = 3.0V$. Timing measurement reference levels for all other speed grades are $V_{OL} = 0.8V$ and $V_{OH} = 2.0V$. Input AC drive levels are $V_{IL} = 0.45V$ and $V_{IH} = 2.4V$.

- 2. $\overline{\text{OE}}$ may be delayed up to t_{CE} t_{OE} after the falling edge of $\overline{\text{CE}}$ without impact on t_{CE} .
- 3. $\overline{\text{OE}}$ may be delayed up to t_{ACC} t_{OE} after the address is valid without impact on t_{ACC} .
- 4. This parameter is only sampled, and is not 100% tested.
- 5. Output float is defined as the point when data is no longer driven.

4 Atmel AT27C010

Atmel AT27C010



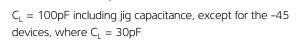


Table 5-5. Pin capacitance $f = 1MHz, T = 25^{\circ}C^{(1)}$

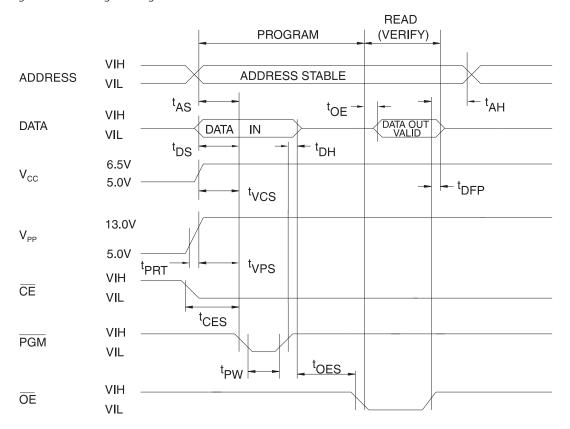
Symbol	Тур	Max	Units	Conditions
C _{IN}	4	8	pF	$V_{IN} = 0V$
C _{OUT}	8	12	pF	V _{OUT} = 0V

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled, and is not 100% tested.





Figure 5-4. Programming Waveforms⁽¹⁾



Notes: 1. The input timing reference is 0.8V for $V_{\rm IL}$ and 2.0V for $V_{\rm IH}$

- 2. $t_{\mbox{\scriptsize OE}}$ and $t_{\mbox{\scriptsize DFP}}$ are characteristics of the device, but must be accommodated by the programmer.
- 3. When programming the Atmel AT27C010, a 0.1 μ F capacitor is required across V_{pp} and ground to suppress spurious voltage transients.

Atmel AT27C010

Table 5-6.DC programming characteristics

 ${\rm T_A} = 25 \pm 5^{\rm o}{\rm C}, \, {\rm V_{CC}} = 6.5 \pm 0.25 {\rm V}, \, {\rm V_{PP}} = 13.0 \pm 0.25 {\rm V}$

			Limits		
Symbol	Parameter	Test conditions	Min	Max	Units
ILI	Input load current	$V_{IN} = V_{IL'} V_{IH}$		±10	μA
VIL	Input low level		-0.6	0.8	V
V _{IH}	Input high level		2.0	V _{CC} + 1	V
V _{OL}	Output low voltage	I _{OL} = 2.1mA		0.4	V
V _{OH}	Output high voltage	I _{OH} = -400μA	2.4		V
I _{CC2}	V _{CC} supply current (program and verify)			40	mA
I _{PP2}	V _{PP} supply current	$\overline{CE} = \overline{PGM} = V_{IL}$		20	mA
V _{ID}	A9 product identification voltage		11.5	12.5	V

Table 5-7. AC programming characteristics

			Limits			
Symbol	Parameter	Test conditions ⁽¹⁾	Min	Max	Units	
t _{AS}	Address setup time		2		μs	
t _{CES}	CE setup time		2		μs	
t _{OES}	OE setup time	Input rise and fall times	2		μs	
t _{DS}	Data setup time	— (10% to 90%) 20ns	2		μs	
t _{AH}	Address hold time	Input pulse levels	0		μs	
t _{DH}	Data hold time	0.45V to 2.4V	2		μs	
t _{DFP}	$\overline{\text{OE}}$ high to output float delay ⁽²⁾	Input timing reference level	0	130	ns	
t _{VPS}	V _{PP} setup time	0.8V to 2.0V	2		μs	
t _{VCS}	V _{CC} setup time		2		μs	
t _{PW}	PGM program pulse width ⁽³⁾	Output timing reference level	95	105	μs	
t _{OE}	Data valid from OE			150	ns	
t _{PRT}	V _{PP} pulse rise time during programming		50		ns	

Notes: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously with or after V_{PP} .

2. This parameter is only sampled, and is not 100% tested. Output float is defined as the point where data is no longer driven. See timing diagram.

3. Program pulse width tolerance is $100\mu \text{sec} \pm 5\%$.

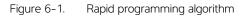
	Pins					Hex				
Codes	A0	07	O6	05	04	O3	02	01	00	data
Manufacturer	0	0	0	0	1	1	1	1	0	1E
Device type	1	0	0	0	0	0	1	0	1	05

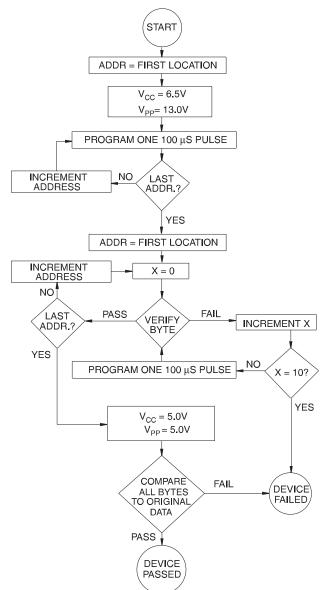




6. Rapid programming algorithm

A 100µs \overrightarrow{PGM} pulse width is used to program. The address is set to the first location. V_{CC} is raised to 6.5V and V_{PP} is raised to 13.0V. Each address is first programmed with one 100µs \overrightarrow{PGM} pulse without verification. Then a verification/reprogramming loop is executed for each address. In the event a byte fails to pass verification, up to 10 successive 100µs pulses are applied with a verification after each pulse. If the byte fails to verify after 10 pulses have been applied, the part is considered failed. After the byte verifies properly, the next address is selected until all have been checked. V_{PP} is then lowered to 5.0V and V_{CC} to 5.0V. All bytes are read again and compared with the original data to determine if the device passes or fails.





7. Ordering information

l_{cc} (mA) t_{ACC} (ns) Active Standby Atmel ordering code Package Lead finish Operation range Industrial 45 25 0.1 AT27C010-45JU 32J Matte tin (-40°C to 85°C) AT27C010-70JU 32J Industrial Matte tin 70 25 0.1 AT27C010-70PU 32P6 Matte tin (-40°C to 85°C)

Green package option (Pb/halide-free)

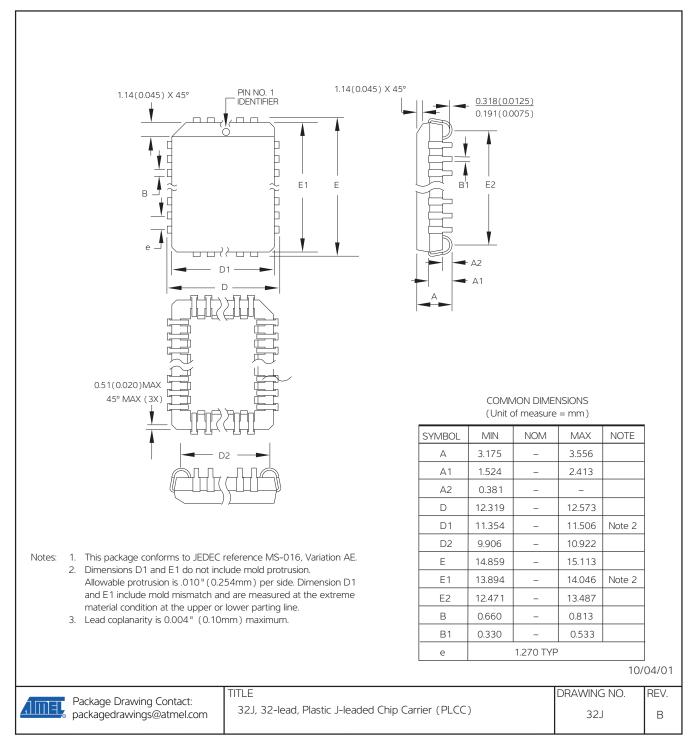
	Package type
32J	32-lead, plastic, J-leaded chip carrier (PLCC)
32P6	32-lead, 0.600" wide, plastic, dual inline package (PDIP)





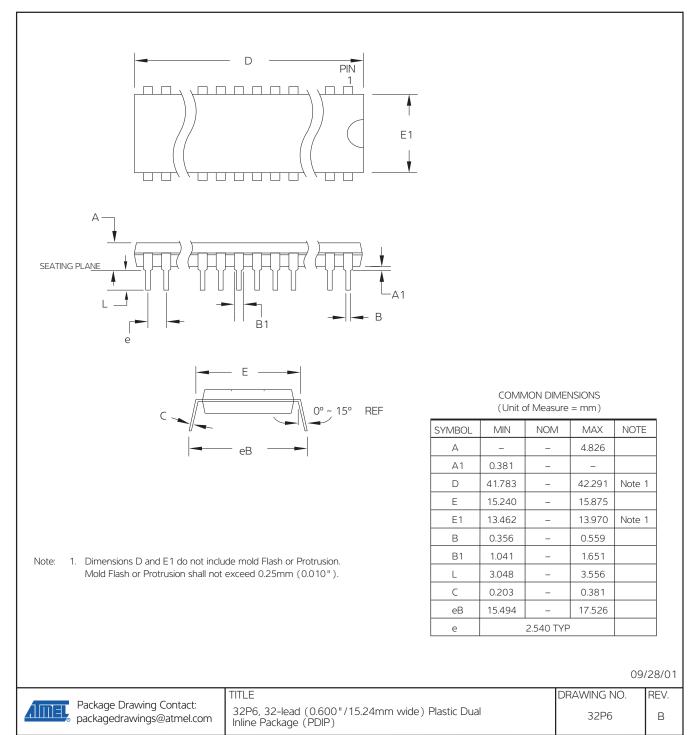
8. Package Information

32J – PLCC



Atmel AT27C010

32P6 – PDIP







9. Revision history

Doc. Rev.	Date	Comments
0321N	04/2011	Remove TSOP package
		Add lead finish to ordering information
0321M	12/2007	



Atmel Corporation

2325 Orchard Parkway San Jose, CA 95131 USA Tel: (+1) (408) 441-0311 Fax: (+1) (408) 487-2600 www.atmel.com Atmel Asia Limited Unit 01-5 & 16, 19F BEA Tower, Millennium City 5 418 Kwun Tong Road Kwun Tong, Kowloon HONG KONG Tel: (+852) 2245-6100 Fax: (+852) 2722-1369

Atmel Munich GmbH

Business Campus Parkring 4 D-85748 Garching b. Munich GERMANY **Tel:** (+49) 89-31970-0 **Fax:** (+49) 89-3194621

Atmel Japan

9F, Tonetsu Shinkawa Bldg. 1-24-8 Shinkawa Chuo-ku, Tokyo 104-0033 JAPAN **Tel:** (+81) (3) 3523-3551 **Fax:** (+81) (3) 3523-7581

© 2011 Atmel Corporation. All rights reserved. / Rev.: 0321N-EPROM-4/11

Atmel[®], logo and combinations thereof, and others are registered trademarks or trademarks of Atmel Corporation or its subsidiaries. Other terms and product names may be trademarks of others.

Disclaimer: The information in this document is provided in connection with Atmel products. No license, express or implied, by estoppel or otherwise, to any intellectual property right is granted by this document or in connection with the sale of Atmel products. EXCEPT AS SET FORTH IN THE ATMEL TERMS AND CONDITIONS OF SALES LOCATED ON THE ATMEL WEBSITE, ATMEL ASSUMES NO LABILITY WHATSOEVER AND DISCLAIMS ANY EXPRESS, IMPLIED OR STATUTORY WARRANTY RELATING TO IS PRODUCTS INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINCEMENT. IN NO EVENT SHALL ATMEL BE LIABLE FOR ANY DIRECT, INDIRECT, CONSEQUENTIAL, PUNITIVE, SPECIAL OR INCIDENTAL DAMAGES (INCLUDING, WITHOUT LIMITATION, DAMAGES FOR LOSS AND PROFITS, BUSINESS INTERRUPTION, OR LOSS OF INFORMATION) ARISING OUT OF THE USE OR INABILITY TO USE THIS DOCUMENT, EVEN IF ATMEL HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. Atmel makes no representations or warranties with respect to the accuracy or completeness of the contents of this document and reserves the right to make changes to specifications and products descriptions at any time without notice. Atmel does not make any commitment to update the information contained herein. Unless specifically provided otherwise, Atmel products are not suitable for, and shall not be used in, automotive applications. Atmel products are not intended, authorized, or warranted for use as components in intended to support or sustain life.



OUR CERTIFICATE

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we striciy control the quality of products and services. Welcome your RFQ to Email: Info@DiGi-Electronics.com

	<section-header></section-header>		
Marginary Marginary Marginary	Market	Marchine Marchine Image: Control of the sector of the sec	





Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.